

	Type	L #	Hits	Search Text	DBs	Time Stamp	Comments	Error Definition	Errors
53	BRS	L53	15	lithographic and (resilient or flexible or compliant) adj (pins or leads or contacts)	USPA T	2004/05/05 11:26			0
54	BRS	L54	469	lithographic and (resilient or flexible or compliant) same (pins or leads or contacts)	USPA T	2004/05/05 11:56			0
55	BRS	L55	1654	((liquid or coolant) same cooling) and (resilient or flexible or compliant) same (pins or leads or contacts)	USPA T	2004/05/05 11:57			0
56	BRS	L56	54	((liquid or coolant) same cooling same package) and (resilient or flexible or compliant) same (pins or leads or contacts)	USPA T	2004/05/05 12:04			0
57	BRS	L57	205	((liquid or coolant) same cooling same package) and cavity	USPA T	2004/05/05 12:10			0
58	BRS	L58	3248	((liquid or coolant) same cooling same cavity)	USPA T	2004/05/05 12:10			0
59	BRS	L59	3180	58 not 57	USPA T	2004/05/05 12:10			0
60	BRS	L60	115	(257/\$.ccls. or 361/\$.ccls.) and 59	USPA T	2004/05/05 12:11			0

	Type	L #	Hits	Search Text	DBs	Time Stamp	Comments	Error Definition	Errors
1	IS&R	L1	12	((("4000509") or ("4561040") or ("4820976") or ("4860444") or ("5102343") or ("5198753") or ("5550482") or ("5834946") or ("6033935") or ("6078500") or ("6085831") or ("6468098")).PN. or (2002/0004320).CCLS.	USPA T	2004/05/04 13:55			0
2	BRS	L2	6	package and ((liquid or coolant) same (direct\$2 same cool\$3)) and ((semiconductor or die or ic) same (resilient same contact\$1))	USPA T	2004/05/04 13:59			0
3	BRS	L3	43	package and ((liquid or coolant) same (direct\$2 same cool\$3)) and ((semiconductor or die or ic) same (flexible same contact\$1))	USPA T	2004/05/04 14:07			0
4	BRS	L4	14	package and ((liquid or coolant) same (direct\$2 same cool\$3)) and ((semiconductor or die or ic) same (spring same contact\$1))	USPA T	2004/05/04 14:06			0

	Type	L #	Hits	Search Text	DBs	Time Stamp	Comments	Error Definition	Errors
5	BRS	L5	1	package and ((liquid or coolant) same (direct\$2 same cool\$3)) and ((semiconductor or die or ic) same (flexible same contact\$1))	EPO; JPO; DERW ENT; IBM_ TDB	2004/05/04 14:05			0
6	BRS	L6	0	package and ((liquid or coolant) same (direct\$2 same cool\$3)) and ((semiconductor or die or ic) same (spring same contact\$1))	EPO; JPO; DERW ENT; IBM_ TDB	2004/05/04 14:06			0
7	BRS	L7	0	((liquid or coolant) same (direct\$2 same cool\$3)) and ((semiconductor or die or ic) same (spring same contact\$1))	EPO; JPO; DERW ENT; IBM_ TDB	2004/05/04 14:06			0
8	BRS	L8	42	((liquid or coolant) same (direct\$2 same cool\$3)) and ((semiconductor or die or ic) same (spring same contact\$1))	USPA T	2004/05/04 14:06			0
9	BRS	L9	28	8 not 4	USPA T	2004/05/04 14:06			0
10	BRS	L10	73	((liquid or coolant) same (direct\$2 same cool\$3)) and ((semiconductor or die or ic) same (flexible same contact\$1))	USPA T	2004/05/04 14:08			0

	Type	L #	Hits	Search Text	DBs	Time Stamp	Comments	Error Definition	Errors
11	BRS	L11	30	10 not 3	USPA T	2004/05/04 14:08			0